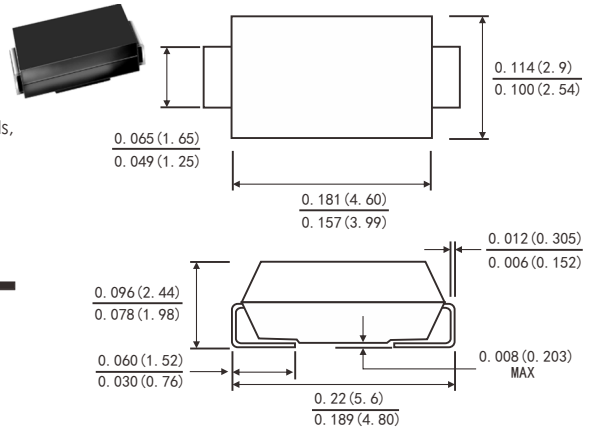


FEATURES

- Glass passivated junction
- For Surface Mount Applications, Easy to pick and place
- Plastic package has Underwriters Laboratory Flammability Classification 94V-0
- High temperature soldering guaranteed: 260°C/10 seconds at terminals,
- Component in accordance to RoHS 2015/863/EU

SMA(DO-214AC)



MECHANICAL DATA

- Case: JEDEC DO-214AC molded plastic over glass passivated chip
- Terminals: Solder plated
- Polarity: Color band denotes cathode end
- Weight: 0.002 ounce, 0.064 g

Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating at 25°C ambient temperature unless otherwise specified. Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.)

Parameters	Symbols	RS1A	RS1B	RS1D	RS1G	RS1J	RS1K	RS1M	Units
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	Volts
Maximum RMS Voltage	V_{RMS}	35	70	140	280	420	560	700	Volts
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	Volts
Maximum Average Forward Rectified Current	$I_{(AV)}$	1.0							Amps
Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	I_{FSM}	30.0							Amps
Maximum Instantaneous Forward Voltage at 1.0 A	V_F	1.3							Volts
Maximum DC Reverse Current at rated DC blocking voltage	$T_A=25^{\circ}C$	5.0							μA
	$T_A=125^{\circ}C$	150							
Maximum reverse recovery time(Note1)	t_{rr}	150			250	500		ns	
Typical junction capacitance(Note3)	C_J	15							pF
Typical thermal resistance (Note 2)	Junction to ambient	$R_{\theta JA}$							$^{\circ}C/W$
	Junction to lead	$R_{\theta JL}$							
Operating junction and storage temperature range	$T_J T_{STG}$	-55 to +150							$^{\circ}C$

Note: 1. Test conditions: $I_F=0.5A, I_R=1.0A, I_{RR}=0.25A$.

2. P.C.B. mounted with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

3. Measured at 1.0MHz and reverse voltage of 4.0 volts

RATINGS AND CHARACTERISTIC CURVES RS1A THRU RS1M

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

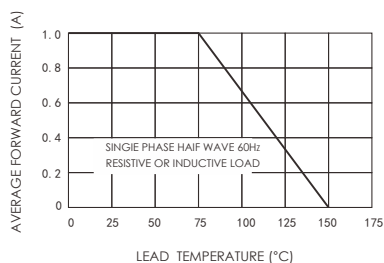


FIG.2-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

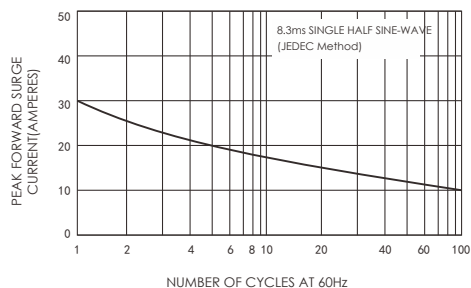


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

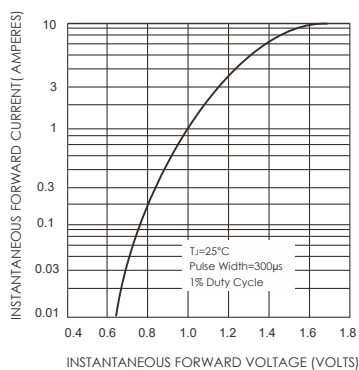


FIG.4-TYPICAL REVERSE CHARACTERISTICS

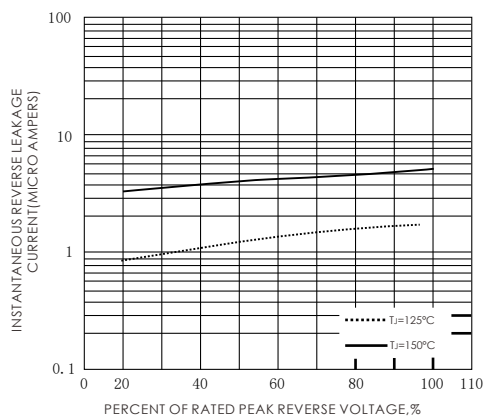


FIG.5-TYPICAL JUNCTION CAPACITANCE

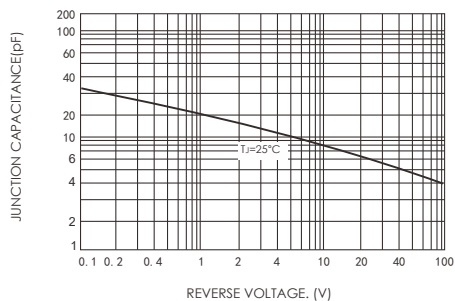


FIG.6-TEST CIRCUIT DIAGRAM AND REVERSE RECOVERY TIME CHARACTERISTIC

